

12-13-2006



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To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

**1. Name of conveying party(ies)**

- 1) Eun-Seok Shin
- 2) Hee-Cheol Choi
- 3) Seung-Hoon Lee
- 4) Kyung-Hoon Lee
- 5) Young-Jae Cho

Additional name(s) of conveying party(ies) attached?  Yes  No

**3. Nature of conveyance/Execution Date(s):**

Execution Date(s) 1) 11-10-2006; 2-5) 11-13-2006

- Assignment
- Security Agreement
- Joint Research Agreement
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other
- Merger
- Change of Name

**2. Name and address of receiving party(ies)**

Name: Samsung Electronics Co., Ltd.

Internal Address: \_\_\_\_\_

Street Address: 416, Maetan-dong,

Yeongtong-gu

City: Suwon-si, Gyeonggi-do

State: \_\_\_\_\_

Country: Republic of Korea Zip: \_\_\_\_\_

Additional name(s) & address(es) attached?  Yes  No

**4. Application or patent number(s):**

This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

12/08 2006 WABDELRI 00000011 11634752

05 FC 8021 40.00 DP Additional numbers attached?  Yes  No

**5. Name and address to whom correspondence concerning document should be mailed:**

Name: David M. Mello

Internal Address: \_\_\_\_\_

Street Address: Eleven Beacon Street

Suite 605

City: Boston

State: Massachusetts Zip: 02108

Phone Number: (617) 994-4900

Fax Number: (617) 742-7774

Email Address: mail@millsonello.com

**6. Total number of applications and patents involved: 1**

**7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00**

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

**8. Payment Information**

a. Credit Card Last 4 Numbers 1009  
Expiration Date 11/08

b. Deposit Account Number \_\_\_\_\_

Authorized User Name \_\_\_\_\_

**9. Signature:**

David M. Mello  
Signature

Dec. 6, 2006  
Date

David M. Mello, Reg. No. 43,799  
Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 7

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:  
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, V.A. 22313-1450

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11/634752

120606

112919 U.S. PTO  
11/634752  
120606

2. Name and address of receiving party(ies):

Name: Industry-University Cooperation Foundation Sogang University  
Street Address: 1-1 Sinsu-dong, Mapo-gu  
City: Seoul  
Country: Republic of Korea

ASSIGNMENT

We, Eun-Seok Shin, of 2/6 200-13 Hyochang-dong, Yongsan-gu, Seoul, Republic of Korea and Hee-Cheol Choi, of 612-1202 Sinnamusil Geukdong Apt., 967-2 Yeongtong-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, being co-inventors of improvements in CAPACITOR AND CAPACITOR ARRAY described in an application for Letters Patent of the United States, executed by us on even date herewith, for good and valuable consideration, receipt of which is hereby acknowledged from Samsung Electronics Co., Ltd., a Korean corporation having a place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea (and hereinafter called the Assignee, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assignee our entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration We do also hereby sell, assign, and transfer unto the Assignee, all our rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of said inventions and said application, and We do hereby authorize the Assignee to apply in our name or its own name or its designee for patents and like rights of exclusion on or for said inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of said application under the provisions of said Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, We do hereby agree for ourselves and for our heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns;

And We do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignee, any and all patents and like rights of exclusion which may be granted in any country upon said United States application on or for said inventions;

And We do hereby covenant for ourselves and our legal representatives and agree with the Assignee, that We have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by us, and that We have not executed and will not execute any instruments in conflict herewith.



Reference No.: SAM-1023

First or Sole Inventor:

Signature: Shin Eun Seok Date: 2006.11.10  
Eun-Seok Shin

Second Joint Inventor:

Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Hee-Cheol Choi

REFERENCE NO.: SAM-1023  
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PATENT  
REEL: 018682 FRAME: 0746

Reference No.: SAM-1023

First or Sole Inventor:

Signature:

Bun-Seok Shin

Date:

Second Joint Inventor:

Signature:

Hee-Cheol Choi  
Hee-Cheol Choi

Date:

13. Nov. 2006

REFERENCE NO.: SAM-1023  
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**ASSIGNMENT**

We, Seung-Hoon Lee, of as810 Sogang Univ., Sinsu 1-dong, Mapo-gu, Seoul, Republic of Korea; Kyung-Hoon Lee, of as810 Sogang Univ., Sinsu 1-dong, Mapo-gu, Seoul, Republic of Korea; and Young-Jae Cho, of as810 Sogang Univ., Sinsu 1-dong, Mapo-gu, Seoul, Republic of Korea, being co-inventors of improvements in CAPACITOR AND CAPACITOR ARRAY described in an application for Letters Patent of the United States, executed by us on even date herewith, for good and valuable consideration, receipt of which is hereby acknowledged from Industry-University Cooperation Foundation Sogang University, a Korean corporation having a place of business at 1-1 Sinsu-dong, Mapo-gu, Seoul, Republic of Korea (and hereinafter called the Assignee, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assignee our entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration We do also hereby sell, assign, and transfer unto the Assignee, all our rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of said inventions and said application, and We do hereby authorize the Assignee to apply in our name or its own name or its designee for patents and like rights of exclusion on or for said inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of said application under the provisions of said Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, We do hereby agree for ourselves and for our heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns;

And We do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignee, any and all patents and like rights of exclusion which may be granted in any country upon said United States application on or for said inventions;

And We do hereby covenant for ourselves and our legal representatives and agree with the Assignee, that We have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by us, and that We have not executed and will not execute any instruments in conflict herewith.

Reference No.: SAM-1023

First or Sole Inventor:

Signature:   
Seung-Hoon Lee

Date: 11/13/2006

Second Joint Inventor:

Signature: Kyung-Hoon Lee.  
Kyung-Hoon Lee

Date: 13. Nov. 2006

Third Joint Inventor:

Signature: Young-Jae Cho  
Young-Jae Cho

Date: 13. Nov. 2006

REFERENCE NO.: SAM-1023  
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